

2SC2545, 2SC2546, 2SC2547

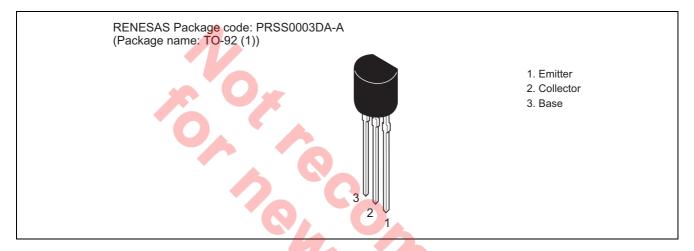
Silicon NPN Epitaxial

REJ03G0699-0300 (Previous ADE-208-1067A) Rev.3.00 Aug.10.2005

Application

Low frequency low noise amplifier

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	2SC2545	2SC2546	2SC2547	Unit
Collector to base voltage	V _{CBO}	60	90	120	V
Collector to emitter voltage	V _{CEO}	60	90	120	V
Emitter to base voltage	V_{EBO}	5	5	5	V
Collector current	Ic	100	100	100	mA
Emitter current	I _E	-100	-100	-100	mA
Collector power dissipation	Pc	400	400	400	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

Electrical Characteristics

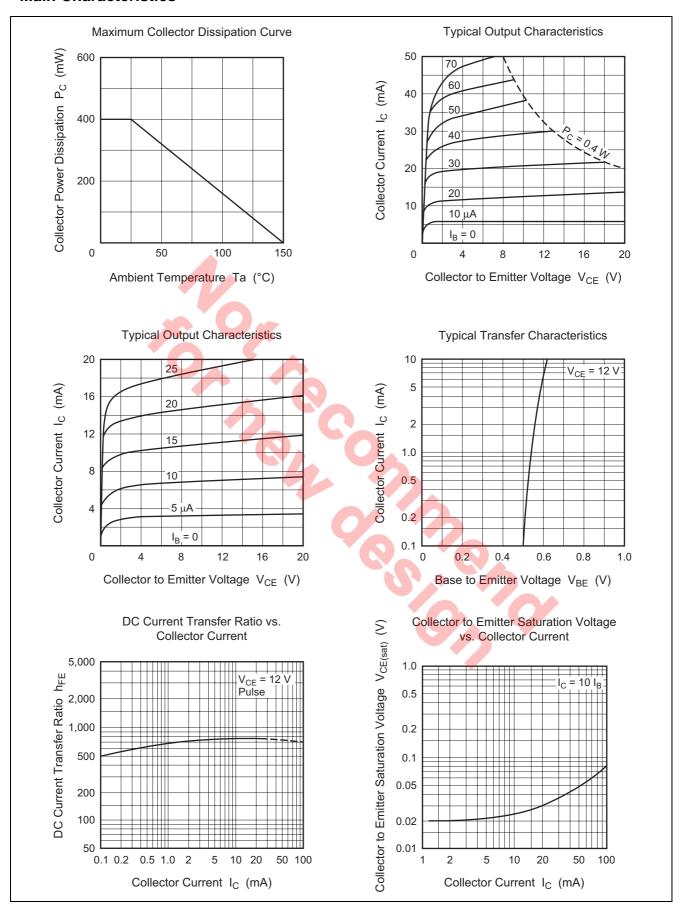
 $(Ta = 25^{\circ}C)$

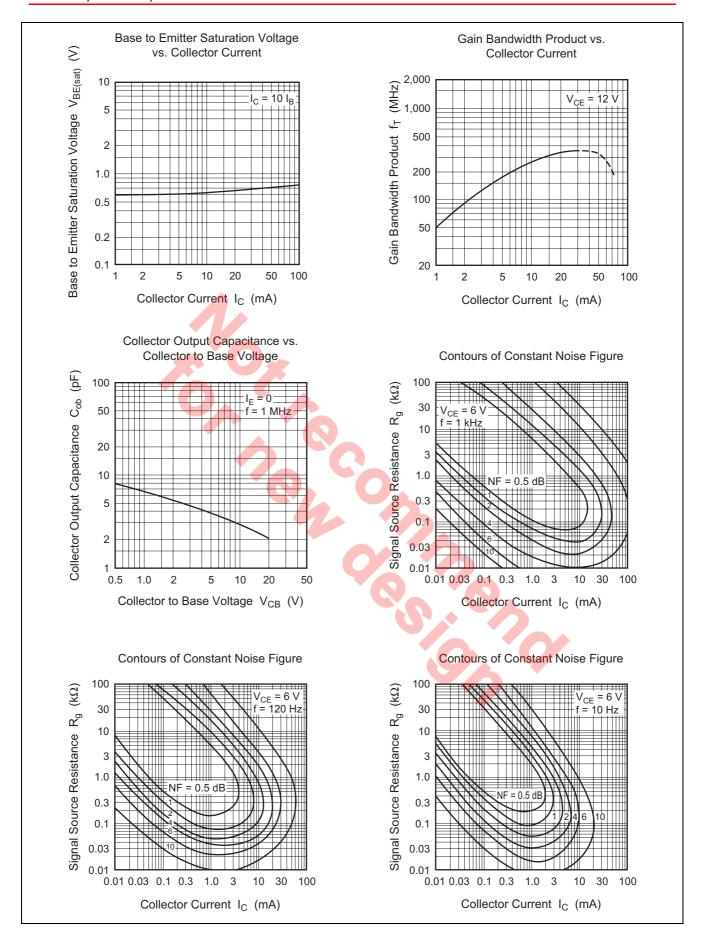
		2SC2545		2SC2546		2SC2547						
Item	Symbol	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown	V _{(BR)CBO}	60	_	_	90	_	_	120	_	_	V	$I_C = 10 \mu A, I_E = 0$
voltage												
Collector to emitter	$V_{(BR)CEO}$	60	_	_	90		_	120	_	_	V	$I_C = 1 \text{ mA},$
breakdown voltage												R _{BE} = ∞
Emitter to base breakdown	$V_{(BR)EBO}$	5	_	_	5		_	5	_	_	V	$I_E = 10 \mu\text{A}, I_C = 0$
voltage												
Collector cutoff current	I _{CBO}	_	_	0.1			0.1	_	_	0.1	μΑ	$V_{CB} = 50 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	_	0.1	_	_	0.1	_	_	0.1	μΑ	$V_{EB} = 2 \text{ V}, I_{C} = 0$
DC current transfer ratio	h _{FE} *1	250	_	1200	600	_	1200	250	_	800		V _{CE} = 12 V,
												$I_C = 2 \text{ mA}$
Collector to emitter	V _{CE(sat)}	_	_	0.2	_	_	0.2	_	_	0.2	V	$I_C = 10 \text{ mA},$
saturation voltage		7										$I_B = 1 \text{ mA}$
Base to emitter voltage	V _{BE}		0.6	_	_	0.6	_	_	0.6	_	V	V _{CE} = 12 V,
												$I_C = 2 \text{ mA}$
Gain bandwidth product	f _T		90			90	_		90	_	MHz	V _{CE} = 12 V,
												$I_C = 2 \text{ mA}$
Collector output capacitance	Cob	_	3.0			3.0	_	_	3.0	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0,$
												f = 1 MHz
Noise voltage referred input	e _n	7	0.5	1	7	0.5	_		0.5	_	nV/	$V_{CE} = 6V$,
	•			-							$\sqrt{\text{Hz}}$	$I_C = 10 \text{ mA},$
												f = 1 kHz,
												$R_g = 0$, $\Delta f = 1Hz$

Note: 1. The 2SC2545 and 2SC2547 are grouped by hFE as follows.

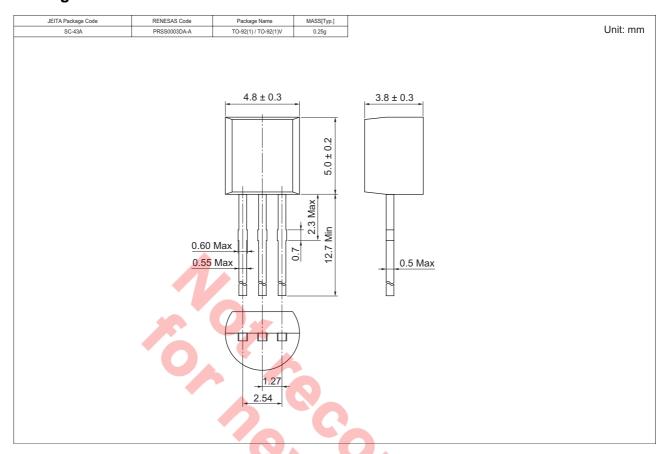
Note: 1. The 2SC2	545 and 2502	547 are group	ed by n _{FE} as to	DIIOWS.
	D	E	F	
2SC2545	_	400 to 800	600 to 1200	
2SC2547	250 to 500	400 to 800	_	
				-0
				· ·

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC2545ETZ-E	2500	Hold Box, Radial Taping
2SC2545FTZ-E		
2SC2546FTZ-E		
2SC2547ETZ-E		

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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